

Product Termination Notification (PTN): Obsolescence of Type 9, 80nm 3V DeMux and 1.8V Mux, pSRAM Multi-Chip Package (MCP) Products



PTN#: 2870

Issue Date: November 15, 2013

Overview:

Spansion LLC is announcing the obsolescence of the multi-chip package (MCP) products using 16Mb and 32Mb Type 9, 80nm 3V Demultiplexed pSRAM and 32Mb and 128Mb Type 9, 80nm 1.8V Multiplexed I/O, Burst pSRAM. See below for details:

Product Identification:

S71GL032NA0BHW0P0	S98GL064NB0HI0040	S71VS256RD0AHK3Lx
S71GL032NA0BHW0K0	S71VS064RB0AHT3Lx	S71VS256RD0AHK3Mx
S71GL064NB0BHW0P0	S71VS064RB0AHTBLx	S71NS512RD0ZHEML0
S71GL064NB0BHW0P3	S71VS064RB0AHT3Mx	S71NS512RD0ZHEML3
S71GL064NB0BHW0K0	S71VS064RB0AHTBMx	S98NS256RB0HW0010
S98GL064NB0HI0030	S71VS128RB0AHK3Lx	S98WS064RA0HI007x
S98GL064NB0HI0033	S71VS128RB0AHKBLx	

Package Types Affected:

NLB056, RLG052, RLA056, TLB088, TLC056

Description of Obsolescence:

Obsolescence of all valid combinations of 16Mb and 32Mb Type 9, 80nm 3V Demultiplexed pSRAM and 32Mb and 128Mb Type 9, 80nm 1.8V Multiplexed I/O, Burst pSRAM Multi-Chip Package (MCP) Products.

Reason for Obsolescence:

The Fab where the commercial die products are manufactured will no longer support manufacturing of this pSRAM. This is an unusual circumstance in which Spansion will not be able to provide the standard six month last time buy period. To ensure Spansion can provide support to transition to a replacement device, final orders must be placed by March 1, 2014.

Anticipated Impact:

The ordering part number will no longer be offered.

Recommended Replacement Part:

Obsoleted Product	Closest Replacement
S71GL032NA0BHW0Px S71GL032NA0BHW0Kx	Contact Factory

S71GL064NB0BHW0Px S71GL064NB0BHW0Kx	Contact Factory
S98GL064NB0HI003x S98GL064NB0HI004x	Contact Factory
S71VS064RB0AHT3Lx S71VS064RB0AHT3Mx ⁽¹⁾	S71VS064RB0AHT4Lx
S71VS064RB0AHTBLx S71VS064RB0AHTBMx ⁽¹⁾	S71VS064RB0AHTCLx
S71VS128RB0AHK3Lx	S71VS128RB0AHK4Lx
S71VS128RB0AHKBLx	S71VS128RB0AHKCLx
S71VS256RD0AHK3Lx S71VS256RD0AHK3Mx	Contact Factory
S71NS512RD0ZHEMLx	Contact Factory
S98NS256RB0HW001x	Contact Factory
S98WS064RA0HI007x	Contact Factory

(1) Obsolete device supports industrial temperature (-40°C to +85°C). Replacement part supports wireless temperature (-25°C to +85°C). Contact Factory for additional details.

Qualification Status:

Replacement devices have been previously qualified, unless specifically noted.

Last Order Date: March 1, 2014

Last Shipment Date: September 1, 2014

Products Affected By This Obsolescence

S71GL032NA0BHW0K0	S71VS064RB0AHTBL0	S71VS256RD0AHK3M3
S71GL032NA0BHW0P0	S71VS064RB0AHTBL3	S71VS064RB0AHTBM3
S71GL064NB0BHW0K0	S71VS064RB0AHTBM0	S98GL064NB0HI0030
S71GL064NB0BHW0P0	S71VS064RB0AHTBM3	S98GL064NB0HI0033
S71GL064NB0BHW0P3	S71VS128RB0AHK3L0	S98GL064NB0HI0040
S71NS512RD0ZHEML0	S71VS128RB0AHKBL0	S98NS256RB0HW001
S71VS064RB0AHT3L0	S71VS256RD0AHK3L0	S98WS064RA0HI0070
S71VS064RB0AHT3L3	S71VS256RD0AHK3L3	S98WS064RA0HI0073
S71VS064RB0AHT3M0	S71VS256RD0AHK3M0	

Revision History:

The following table shows the revision history for this product termination notification.

Date	Revision	Description
11/15/13	None	Initial Release